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April 1999



SEMICONDUCTOR TM

FDC6321C Dual N & P Channel , Digital FET

General Description

These dual N & P Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors in load switching applications. Since bias resistors are not required this dual digital FET can replace several digital transistors with different bias resistors.

Features

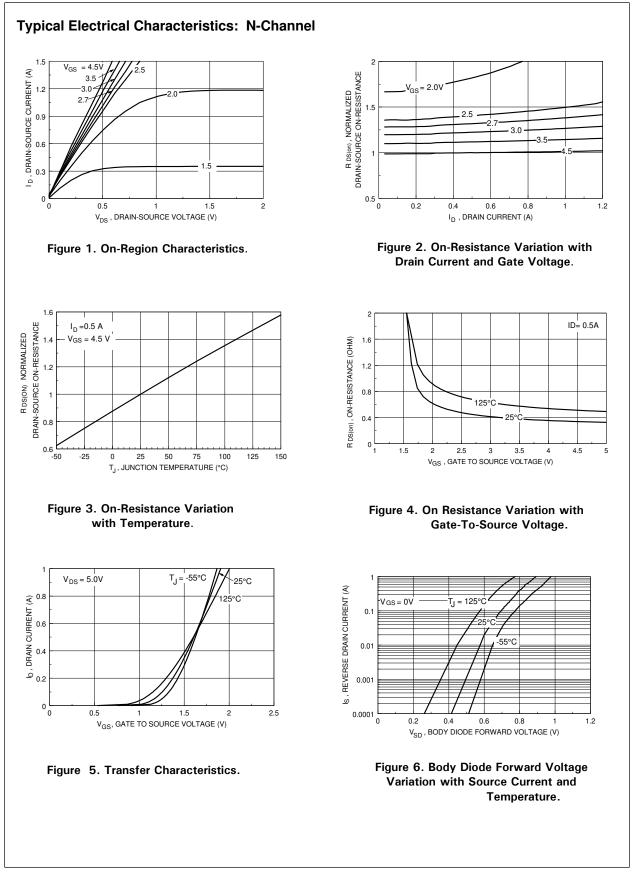
- N-Ch 25 V, 0.68 A, R_{DS(ON)} = 0.45 Ω @ V_{GS}= 4.5 V
- P-Ch -25 V, -0.46 A, $R_{DS(ON)} = 1.1 \Omega @ V_{GS} = -4.5 V.$
- Very low level gate drive requirements allowing direct operation in 3 V circuits. V_{GS(th)} < 1.0V.
- Gate-Source Zener for ESD ruggedness.
 >6kV Human Body Model
- Replace multiple dual NPN & PNP digital transistors.

						0000000
SOT-2	3	SuperSOT [™] -6	SuperSOT [™] -8	SO-8	SOT-223	SOIC-16
		Mark:.321				
		D2 D1 D1 SOT ™-6	G2 S2 S1	4 5 6		2
	ute Maxim	um Ratings	$\Gamma_{\rm A} = 25^{\circ}$ C unless other wise	e noted N-Channel	P-Cha	annel Units
ymbol	Parameter	um Ratings			P-Cha	
ymbol _{DSS} , V _{CC}	Parameter	e Voltage, Power S		N-Channel		25 V
ymbol _{DSS} , V _{CC} _{GSS} , V _{IN}	Parameter Drain-Sourc	ce Voltage, Power S e Voltage,		N-Channel 25	-2	25 V 8 V
ymbol _{DSS} , V _{CC} _{GSS} , V _{IN}	Parameter Drain-Sourc Gate-Sourc	ce Voltage, Power S e Voltage,	upply Voltage	N-Channel 25 8	-2	25 V 3 V 46 A
ymbol _{DSS} , V _{CC} _{GSS} , V _{IN} , I _O	Parameter Drain-Source Gate-Source Drain/Outpu	e Voltage, Power S e Voltage, ut Current - Cor	upply Voltage	N-Channel 25 8 0.68	-2 -2 -6.	25 V 3 V 46 A
ymbol $_{DSS}, V_{CC}$ $_{GSS}, V_{IN}$ $, I_{O}$	Parameter Drain-Sourc Gate-Sourc Drain/Outpu Maximum F	e Voltage, Power S e Voltage, ut Current - Cor - Pul:	iupply Voltage ntinuous sed (Note 1a) (Note 1b)	N-Channel 25 8 0.68	-2 -2 -0.4 -0.4 -1. 0.9	25 V 3 V 46 A .5
ymbol _{DSS} , V _{CC} _{GSS} , V _{IN} , I _O D J,T _{STG}	Parameter Drain-Sourc Gate-Sourc Drain/Outpu Maximum F Operating a Electrostatic	ce Voltage, Power S e Voltage, ut Current - Cor - Pul: Power Dissipation	tupply Voltage ntinuous sed (Note 1a) (Note 1b) ure Ranger MIL-STD-883D	N-Channel 25 8 0.68	-2 -2 -6 -0.4 -1. 0.9 0.7	25 V 3 V 46 A .5 W
ymbol _{DSS} , V _{CC} _{GSS} , V _{IN} , I ₀ D , T _{STG} SD	Parameter Drain-Sourc Gate-Sourc Drain/Outpu Maximum F Operating a Electrostatic	e Voltage, Power S e Voltage, ut Current - Cor - Pul: Power Dissipation and Storage Tempat c Discharge Rating dy Model (100pf / 15	tupply Voltage ntinuous sed (Note 1a) (Note 1b) ure Ranger MIL-STD-883D	N-Channel 25 8 0.68	-2 -2 -0.4 -0.4 -1. 0.9 0.7 -55 to 150	25 V 3 V 46 A .5 W
ymbol (_{DSS} , V _{CC} (_{GSS} , V _{IN} (_D), I ₀ (D)	Parameter Drain-Source Gate-Source Drain/Outpu Maximum F Operating a Electrostatice Human Boo	e Voltage, Power S e Voltage, ut Current - Cor - Pul: Power Dissipation and Storage Tempat c Discharge Rating dy Model (100pf / 15	iupply Voltage ntinuous sed (Note 1a) (Note 1b) ure Ranger MIL-STD-883D 500 Ohm)	N-Channel 25 8 0.68	-2 -2 -0.4 -0.4 -1. 0.9 0.7 -55 to 150	25 V 3 V 46 A .5 W C

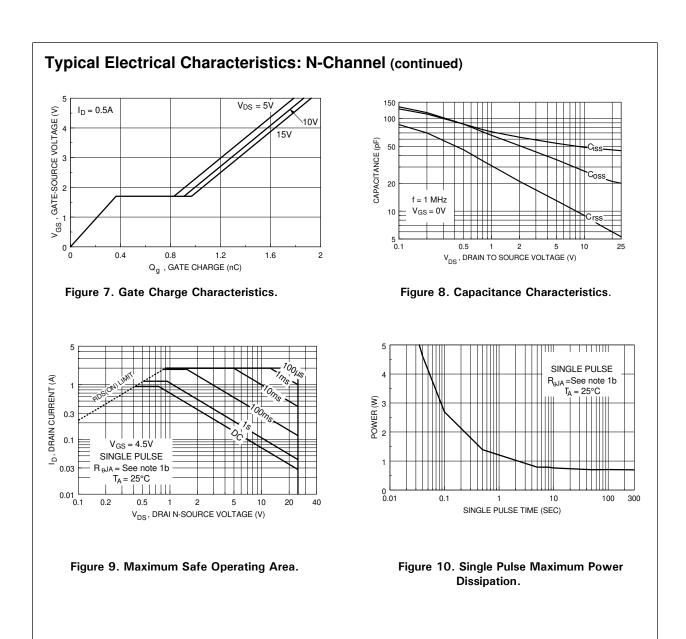
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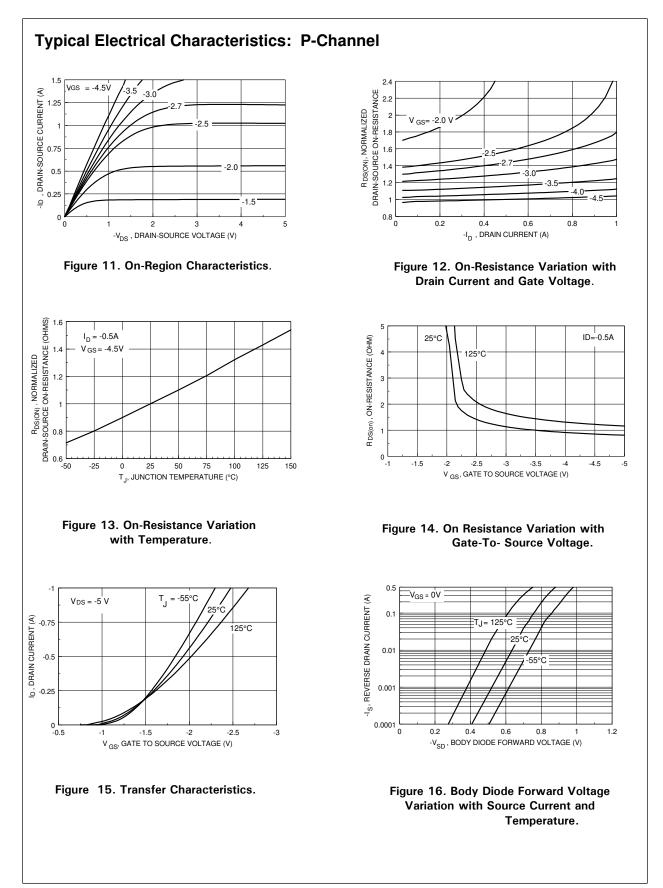
Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units
OFF CHARA	ACTERISTICS					I	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	N-Ch	25			V
200	, i i i i i i i i i i i i i i i i i i i	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	P-Ch	-25			-
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I_{D} = 250 μ A, Referenced to 25 °C	N-Ch		26		mV /°C
		$I_{\rm D}$ = -250 μ A, Referenced to 25 °C	P-Ch		-22		-
DSS	Zero Gate Voltage Drain Current	$V_{\rm DS} = 20 \text{ V}, \ V_{\rm GS} = 0 \text{ V},$	N-Ch			1	μA
		$T_{\rm I} = 55^{\circ}{\rm C}$;			10	1
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V},$	P-Ch			-1	μA
		$T_{J} = 55^{\circ}C$;			-10	1
I _{GSS}	Gate - Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$	N-Ch			100	nA
		$V_{GS} = -8 V, V_{DS} = 0 V$	P-Ch			-100	nA
ON CHARAC	CTERISTICS (Note 2)						
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	I_{D} = 250 μ A, Referenced to 25 °C	N-Ch		-2.6		mV / °C
GO(81) 0		I_{D} = -250 μ A, Referenced to 25 °C	P-Ch		2.1		
V _{GS(th)}	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = 250 \ \mu A$	N-Ch	0.65	0.8	1.5	V
		$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \ \mu A$	P-Ch	-0.65	-0.86	-1.5	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, \ I_{D} = 0.5 \text{ A}$	N-Ch		0.33	0.45	Ω
		T _J =125°C	>		0.51	0.72	
		$V_{GS} = 2.7 \text{ V}, \ I_{D} = 0.25 \text{ A}$			0.44	0.6	
		$V_{GS} = -4.5 \text{ V}, I_{D} = -0.5 \text{ A}$	P-Ch		0.87	1.1	
		T _J =125°C			1.21	1.8	1
		$V_{GS} = -2.7 \text{ V}, \ I_{D} = -0.25 \text{ A}$			1.22	1.5	
D(ON)	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, \ V_{DS} = 5 \text{ V}$	N-Ch	1			A
		$V_{GS} = -4.5 \text{ V}, \ V_{DS} = -5 \text{ V}$	P-Ch	-1			
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \ \text{I}_{D} = 0.5 \text{ A}$	N-Ch		1.45		S
		$V_{DS} = -5 V, I_{D} = -0.5 A$	P-Ch		0.8		
	HARACTERISTICS	1		1		1	1
C _{iss}	Input Capacitance	N-Channel	N-Ch		50		pF
		$V_{DS} = 10 V, V_{GS} = 0 V,$	P-Ch		63		
C _{oss}	Output Capacitance	f = 1.0 MHz	N-Ch		28		pF
		P-Channel	P-Ch		34		
C _{rss}	Reverse Transfer Capacitance	V_{DS} = -10 V, V_{GS} = 0V, f = 1.0 MHz	N-Ch P-Ch		9 10		pF
				L		1	I

	NG CHARACTERISTICS (Note 2)						
Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Units
D(on)	Turn - On Delay Time	N-Channel	N-Ch		3	6	nS
		$V_{\text{DD}} = 6 \text{ V}, \text{ I}_{\text{D}} = 0.5 \text{ A},$	P-Ch		7	20	
	Turn - On Rise Time	$V_{Gs} = 4.5 \text{ V}, \text{ R}_{GEN} = 50 \Omega$	N-Ch		8	16	nS
			P-Ch		9	18	
D(off)	Turn - Off Delay Time	P-Channel	N-Ch		17	30	nS
		$V_{DD} = -6 \text{ V}, \text{ I}_{D} = -0.5 \text{ A},$	P-Ch		55	110	
	Turn - Off Fall Time	$V_{\text{Gen}} = -4.5 \text{ V}, \text{ R}_{\text{GEN}} = 50 \ \Omega$	N-Ch		13	25	nS
			P-Ch		35	70	
ک ^و	Total Gate Charge	N-Channel	N-Ch		1.64	2.3	nC
		$V_{\rm DS} = 5 \text{ V}, \text{ I}_{\rm D} = 0.5 \text{ A},$	P-Ch		1.1	1.5	
ک _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$	N-Ch		0.38		nC
		P- Channel	P-Ch		0.32		
¢ _{gd}	Gate-Drain Charge	V _{DS} = -5 V,	N-Ch		0.45		nC
		$I_{\rm D} = -0.25 \text{ A}, V_{\rm GS} = -4.5 \text{ V}$	P-Ch		0.25		
ORAIN-SC	URCE DIODE CHARACTERISTICS AND MA	AXIMUM RATINGS			1	1	
6	Maximum Continuous Drain-Source Diod	e Forward Current	N-Ch			0.3	A
			P-Ch			-0.5	
/ _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 0.5 A$ (Note)	N-Ch		0.83	1.2	V
		T _J =125%			0.69	0.85	
		$V_{GS} = 0 \text{ V}, \text{ I}_{S} = -0.5 \text{ A} \text{ (Note)}$ $T_{J} = 125^{\circ}\text{C}$	P-Ch		-0.89 -0.75	-1.2 -0.85	
	a. 140°C/W on a 0.125 in² pad of time to be a component of the second se	b. 180°C/W on a 0.005 in ² of pad of 2oz copper.					
999 8	60D						

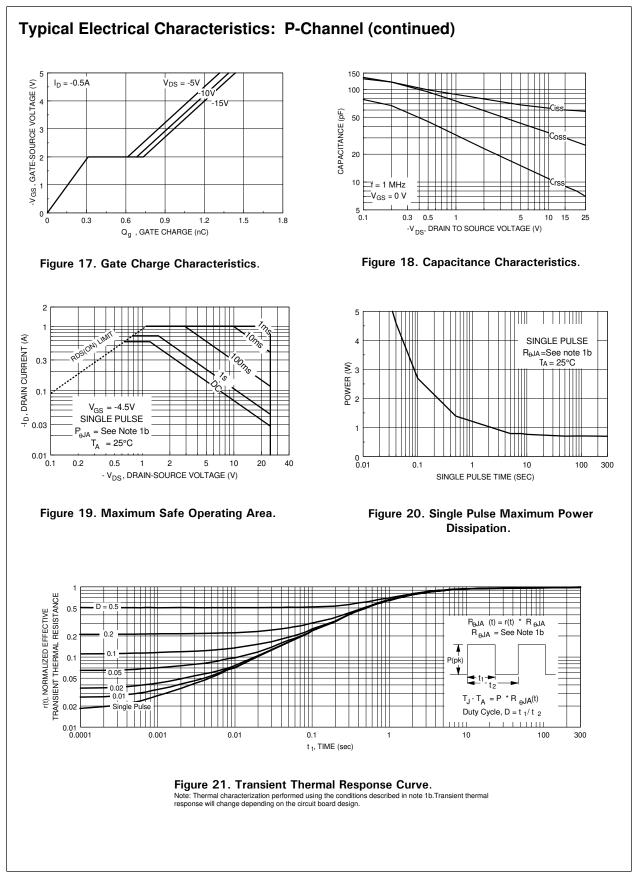


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